



# SOT477D

plastic single-ended multi-chip package; magnetized ferrite magnet (5.5 x 5.5 x 3 mm); 4 interconnections; 3 in-line leads

8 February 2016

Package information

## 1. Package summary

Terminal position code	S (single)
Package type descriptive code	SIP3
Package type industry code	SIP3
Package style descriptive code	SIP (single in-line package)
Package style suffix code	NA (not applicable)
Package body material type	P (plastic)
Mounting method type	T (through-hole mount)
Issue date	11-6-2003

Table 1. Package summary

Symbol	Parameter		Min	Typ	Nom	Max	Unit
D	package length		12.75	-	13	13.25	mm
E	package width		5.5	-	5.6	5.7	mm
A <sub>2</sub>	package height		4.35	-	4.75	4.75	mm
n <sub>2</sub>	actual quantity of termination		-	-	3	-	



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2. Package outline

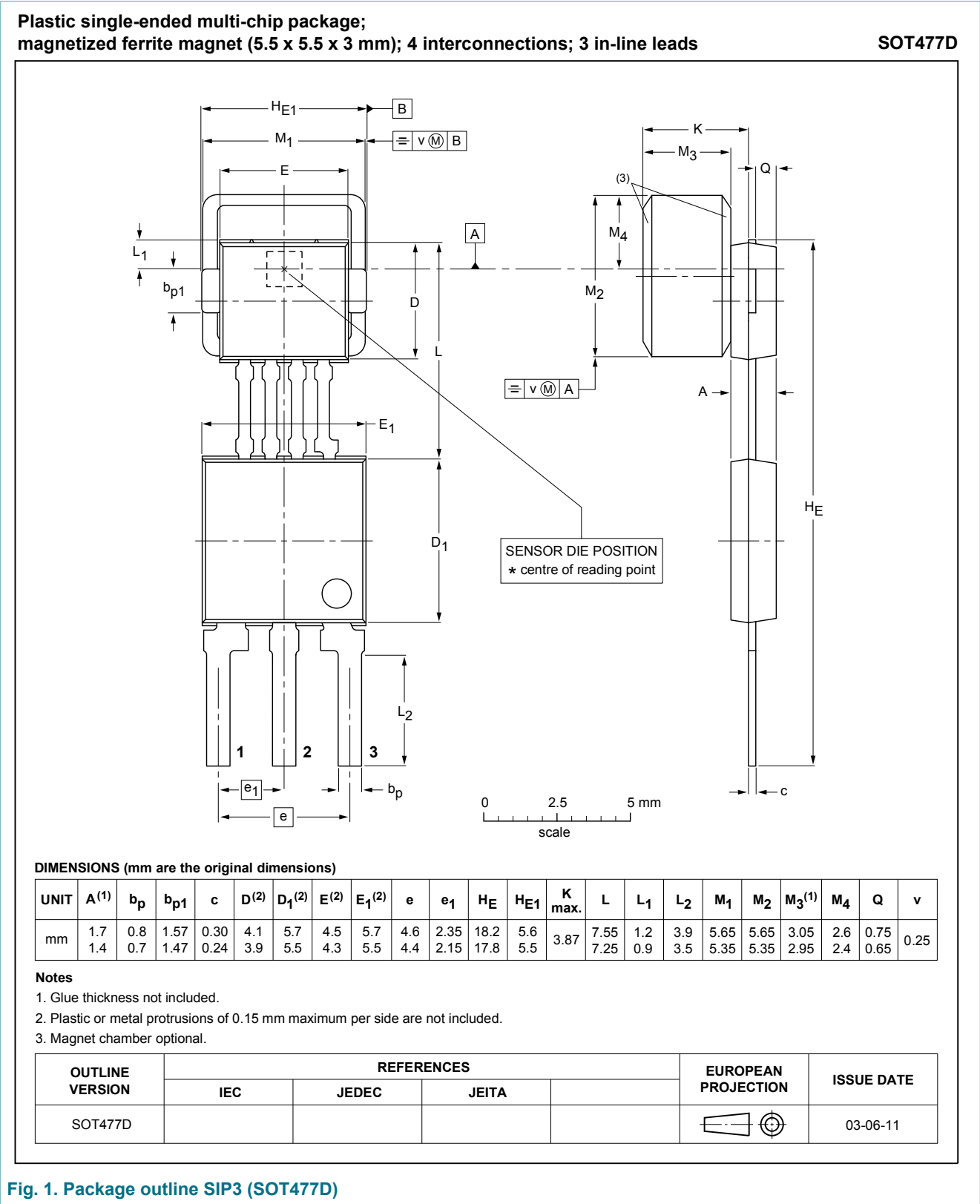


Fig. 1. Package outline SIP3 (SOT477D)

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### 3. Legal information

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